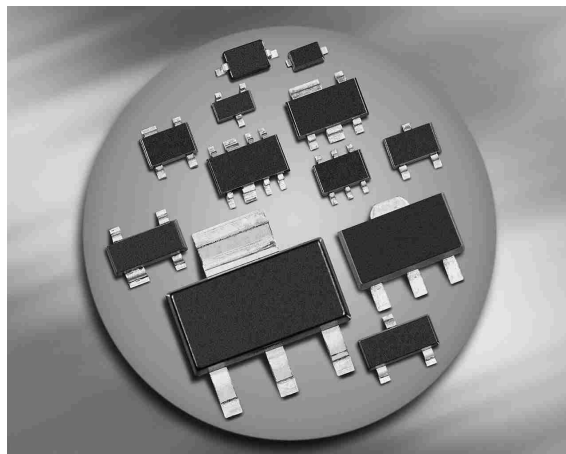


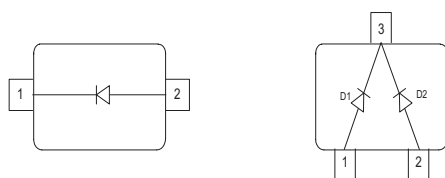
Silicon Tuning Diode

- High Q hyperabrupt tuning diode
- Designed for low tuning voltage operation for VCO's in mobile communications equipment
- High ratio at low reverse voltage
- Pb-free (RoHS compliant) package



BBY53-02L
BBY53-02V
BBY53-02W
BBY53-03W

BBY53
BBY53-05W



Type	Package	Configuration	L_S (nH)	Marking
BBY53	SOT23	common cathode	2	S7s
BBY53-02L	TSLP-2-1	single, leadless	0.4	LL
BBY53-02V	SC79	single	0.6	L
BBY53-02W	SCD80	single	0.6	LL
BBY53-03W	SOD323	single	1.8	white 5
BBY53-05W	SOT323	common cathode	1.4	S7s

Maximum Ratings at $T_A = 25^\circ\text{C}$, unless otherwise specified

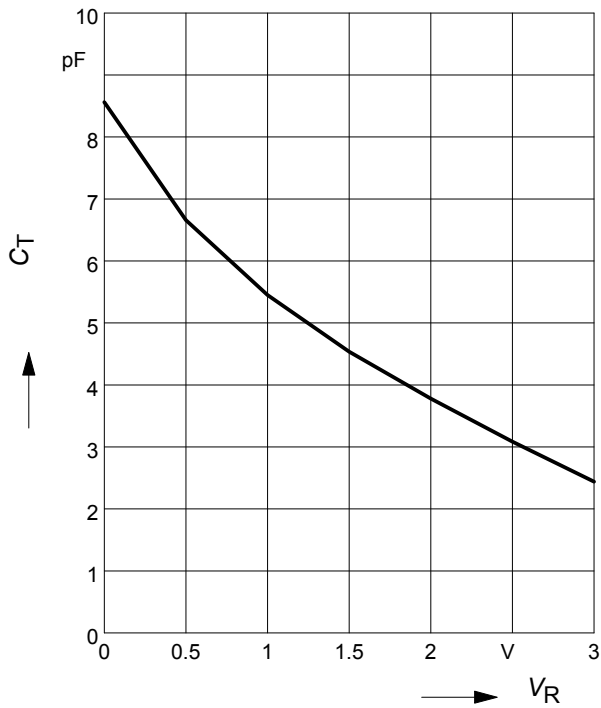
Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	6	V
Forward current	I_F	20	mA
Operating temperature range	T_{op}	-55 ... 125	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 ... 150	

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Reverse current	I_R				nA
$V_R = 4\text{ V}$		-	-	10	
$V_R = 4\text{ V}, T_A = 85\text{ }^{\circ}\text{C}$		-	-	200	
AC Characteristics					
Diode capacitance	C_T				pF
$V_R = 1\text{ V}, f = 1\text{ MHz}$		4.8	5.3	5.8	
$V_R = 3\text{ V}, f = 1\text{ MHz}$		1.85	2.4	3.1	
Capacitance ratio	C_{T1}/C_{T3}	1.8	2.2	2.6	-
$V_R = 1\text{ V}, V_R = 3\text{ V}, f = 1\text{ MHz}$					
Series resistance	r_S	-	0.47	-	Ω
$V_R = 1\text{ V}, f = 1\text{ GHz}$					

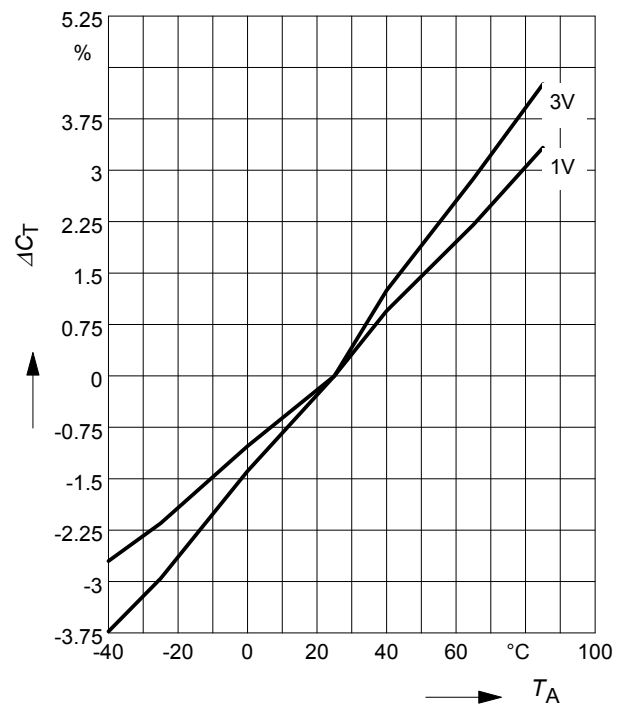
Diode capacitance $C_T = f(V_R)$

$f = 1\text{ MHz}$



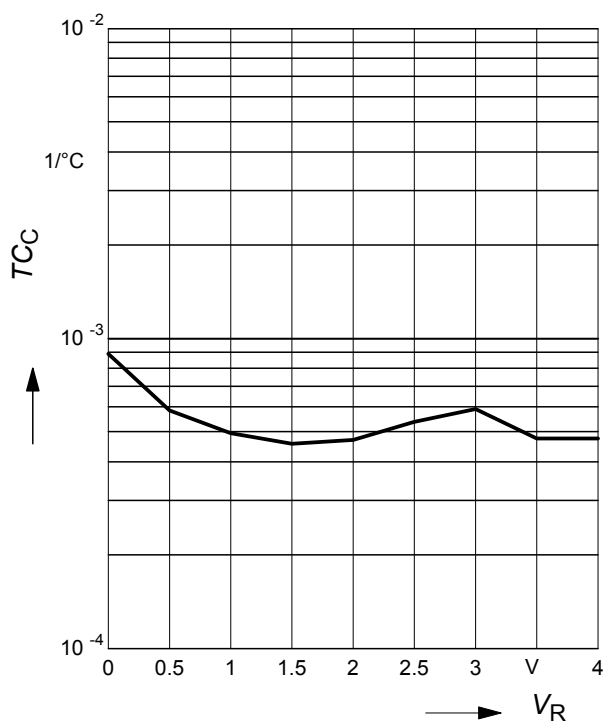
Capacitance change $\Delta C = f(T_A)$

$f = 1\text{ MHz}$

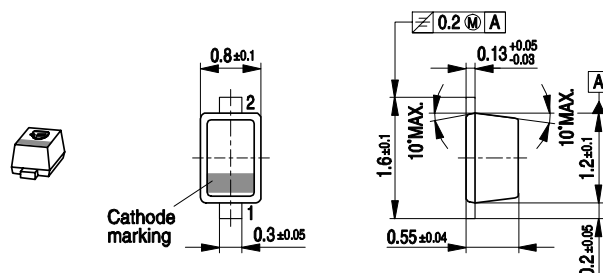


Temperature coefficient of the diode capacitance $TC_C = f(V_R)$

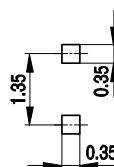
$f = 1\text{ MHz}$



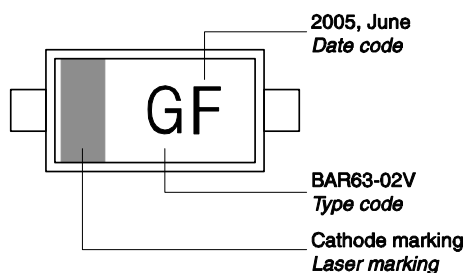
Package Outline



Foot Print

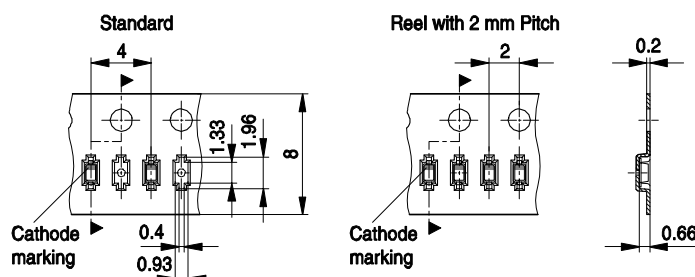


Marking Layout (Example)

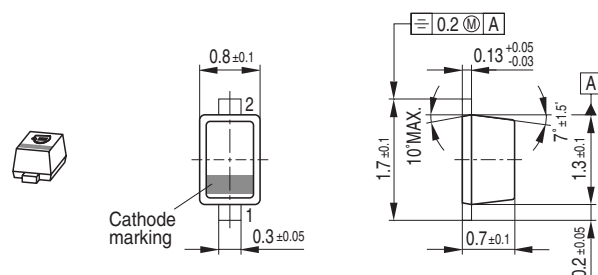


Standard Packing

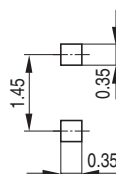
Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø180 mm = 8.000 Pieces/Reel (2 mm Pitch)
 Reel ø330 mm = 10.000 Pieces/Reel



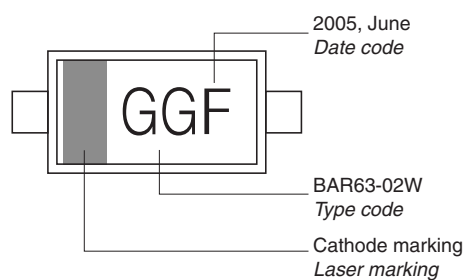
Package Outline



Foot Print

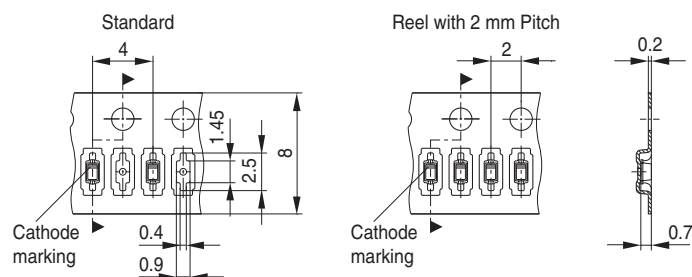


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø180 mm = 8.000 Pieces/Reel (2 mm Pitch)
 Reel ø330 mm = 10.000 Pieces/Reel



Date Code marking for discrete packages with one digit (SCD80, SC79, SC75¹⁾) CES-Code

Month	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014
01	a	p	A	P	a	p	A	P	a	p	A	P
02	b	q	B	Q	b	q	B	Q	b	q	B	Q
03	c	r	C	R	c	r	C	R	c	r	C	R
04	d	s	D	S	d	s	D	S	d	s	D	S
05	e	t	E	T	e	t	E	T	e	t	E	T
06	f	u	F	U	f	u	F	U	f	u	F	U
07	g	v	G	V	g	v	G	V	g	v	G	V
08	h	x	H	X	h	x	H	X	h	x	H	X
09	j	y	J	Y	j	y	J	Y	j	y	J	Y
10	k	z	K	Z	k	z	K	Z	k	z	K	Z
11	l	2	L	4	l	2	L	4	l	2	L	4
12	n	3	N	5	n	3	N	5	n	3	N	5

1) New Marking Layout for SC75, implemented at October 2005.

Technical drawing of the 025A tube pin, showing dimensions in millimeters (mm) and tolerances.

Top View Dimensions:

- Overall width: 2.5 ± 0.2
- Central pin diameter: 0.3 ± 0.05
- Cathode marking area width: $1.25^{+0.2}_{-0.1}$
- Pin diameter: $0.9^{+0.2}_{-0.1}$

Side View Dimensions:

- Base height: 0.45 ± 0.15
- Pin height: $1.7^{+0.2}_{-0.1}$
- Total height: 2.5 ± 0.2
- Base width (bottom): 0.3 ± 0.05
- Base width (top): 0.3 ± 0.05
- Pin diameter (bottom): $0.15^{+0.1}_{-0.06}$

Label: 0.25 A

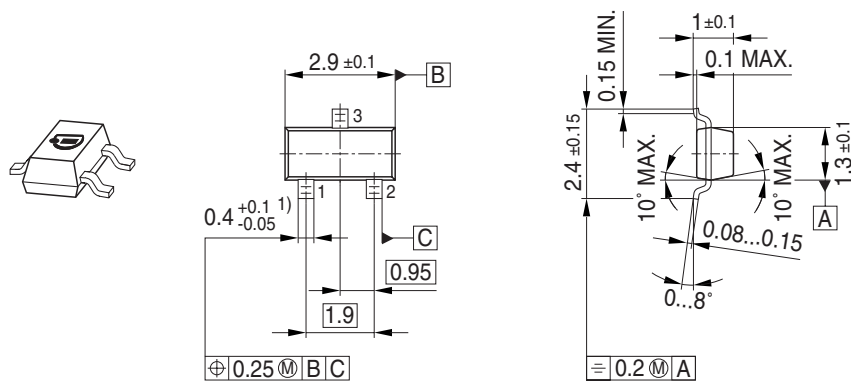
Technical drawing of a stepped shaft. The shaft has a total length of 1.7 units. It consists of two main sections: a left section with a diameter of 0.6 units and a length of 0.8 units, and a right section with a diameter of 0.8 units and a length of 0.8 units. The drawing includes a centerline and dimension lines indicating these measurements.

BAR63-03W
Type code

Cathode marking
Color ink or laser marking

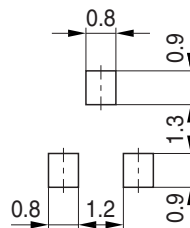
Technical drawing of a cathode marking. The drawing shows a side view and a cross-section. The side view has a total width of 4, a total height of 8, and a central hole with a diameter of 2.9. The cross-section shows a total width of 0.2 and a central hole with a diameter of 1.35. The text "Cathode marking" is written below the side view.

Package Outline

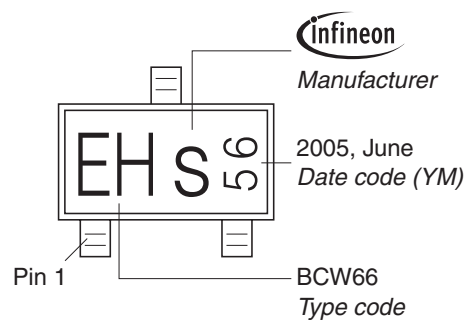


1) Lead width can be 0.6 max. in dambar area

Foot Print

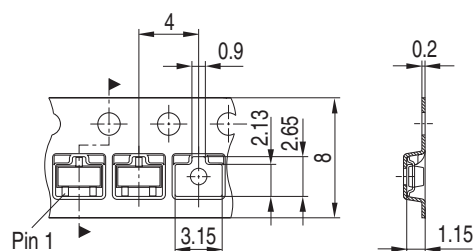


Marking Layout (Example)

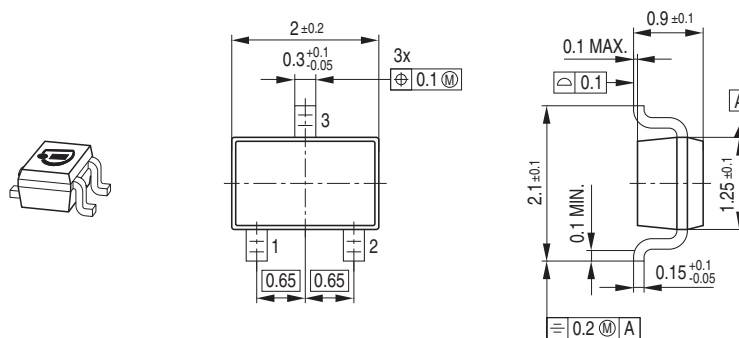


Standard Packing

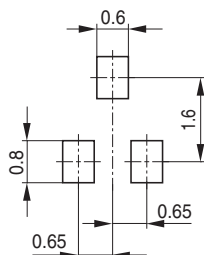
Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



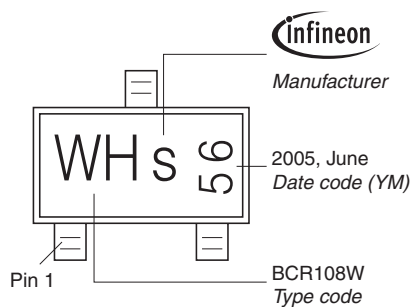
Package Outline



Foot Print

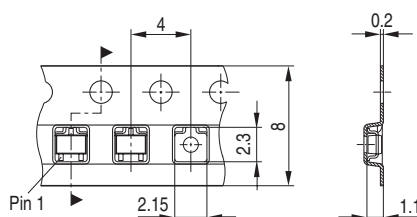


Marking Layout (Example)

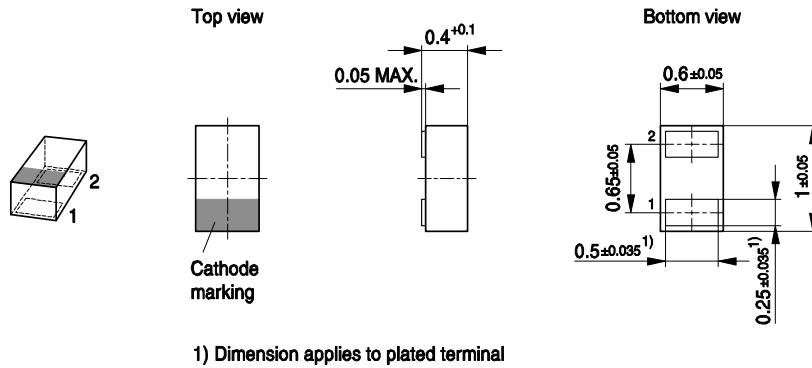


Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø330 mm = 10.000 Pieces/Reel

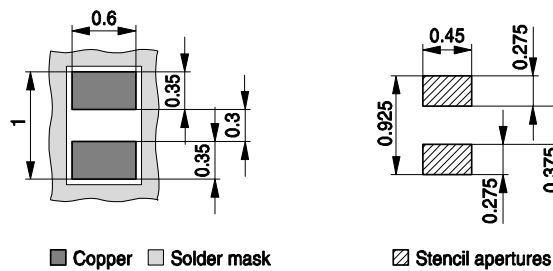


Package Outline

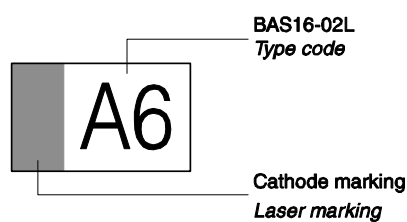


Foot Print

For board assembly information please refer to Infineon website "Packages"

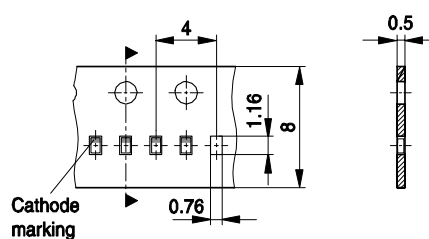


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel
Reel ø330 mm = 50.000 Pieces/Reel (optional)



Edition 2009-11-16

**Published by
Infineon Technologies AG
81726 Munich, Germany**

**© 2009 Infineon Technologies AG
All Rights Reserved.**

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office ([<www.infineon.com>](http://www.infineon.com)).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.